



12N50

Power MOSFET

12A, 500V N-CHANNEL POWER MOSFET

DESCRIPTION

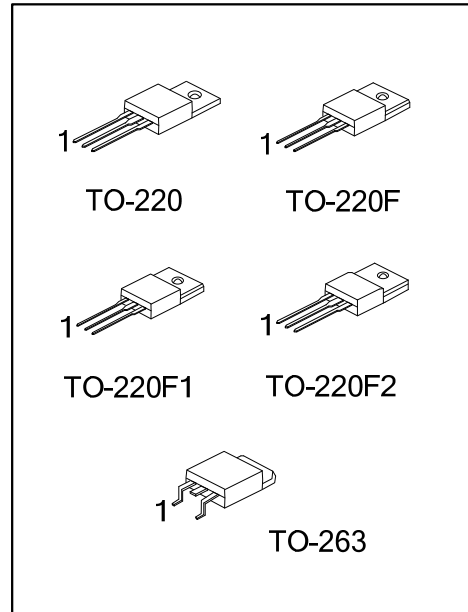
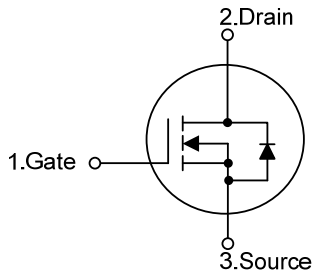
The UTC **12N50** is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **12N50** is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

FEATURES

- * $R_{DS(ON)} < 0.54\Omega @ V_{GS}=10V$
- * High Switching Speed
- * 100% Avalanche Tested

SYMBOL



ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
12N50L-TA3-T	12N50G-TA3-T	TO-220	G	D	S	Tube
12N50L-TF3-T	12N50G-TF3-T	TO-220F	G	D	S	Tube
12N50L-TF1-T	12N50G-TF1-T	TO-220F1	G	D	S	Tube
12N50L-TF2-T	12N50G-TF2-T	TO-220F2	G	D	S	Tube
12N50L-TQ2-T	12N50G-TQ2-T	TO-263	G	D	S	Tube
12N50L-TQ2-R	12N50G-TQ2-R	TO-263	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

12N50L-TA3-T	(1)Packing Type	(1) T: Tube, R: Tape Reel
	(2)Package Type	(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TQ2: TO-263
	(3)Lead Free	(3) L: Lead Free, G: Halogen Free

■ ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	Continuous ($T_C=25^\circ\text{C}$)	I_D	12 (Note 2)	A
	Pulsed (Note 3)	I_{DM}	48 (Note 2)	A
Avalanche Current (Note 3)		I_{AR}	12	A
Avalanche Energy	Single Pulsed (Note 4)	E_{AS}	684	mJ
	Repetitive (Note 5)	E_{AR}	19.5	mJ
Peak Diode Recovery dv/dt (Note 5)		dv/dt	4.5	V/ns
Power Dissipation ($T_C=25^\circ\text{C}$)	TO-220/ TO-263	P_D	195	W
	TO-220F/TO-220F1		42	
	TO-220F2		43	
Derate above 25°C	TO-220/TO-263		1.53	W/ $^\circ\text{C}$
	TO-220F/TO-220F1		0.33	
	TO-220F2		0.34	
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55~+150	$^\circ\text{C}$

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Drain current limited by maximum junction temperature
3. Repetitive Rating: Pulse width limited by maximum junction temperature
4. $L=9.5\text{mH}$, $I_{AS}=12\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$
5. $I_{SD}\leq 12\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ_{JA}	62.5	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220/ TO-263	θ_{JC}	0.65	$^\circ\text{C}/\text{W}$
	TO-220F/TO-220F1		3.0	
	TO-220F2		2.9	

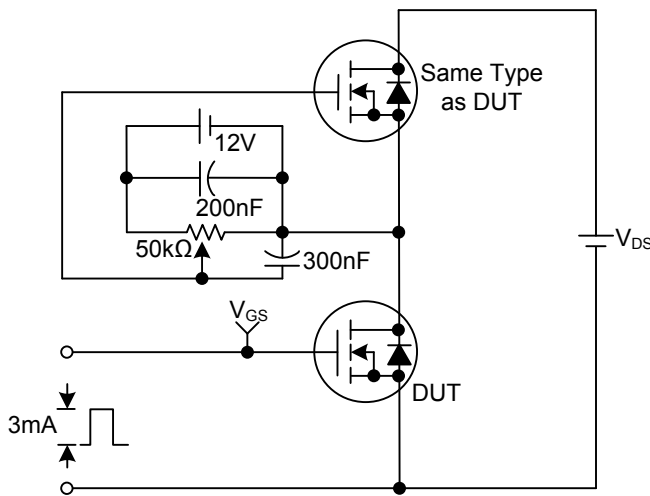
■ ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu\text{A}$, $V_{GS}=0\text{V}$	500			V	
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=500\text{V}$, $V_{GS}=0\text{V}$			10	μA	
Gate- Source Leakage Current	Forward	I_{GSS}			+100	nA	
	Reverse				-100	nA	
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	2.0		4.0	V	
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10\text{V}$, $I_D=6\text{A}$		0.42	0.54	Ω	
DYNAMIC PARAMETERS							
Input Capacitance	C_{ISS}	$V_{GS}=0\text{V}$, $V_{DS}=25\text{V}$, $f=1.0\text{MHz}$		1450	1930	pF	
Output Capacitance	C_{OSS}				198	265	pF
Reverse Transfer Capacitance	C_{RSS}				14.5	22	pF
SWITCHING PARAMETERS							
Total Gate Charge	Q_G	$V_{GS}=10\text{V}$, $V_{DS}=400\text{V}$, $I_D=12\text{A}$ (Note 1, 2)		30	39	nC	
Gate to Source Charge	Q_{GS}				8		nC
Gate to Drain Charge	Q_{GD}				12		nC
Turn-ON Delay Time	$t_{D(ON)}$	$V_{DD}=250\text{V}$, $I_D=12\text{A}$, $R_G=25\Omega$ (Note 1, 2)		28	65	ns	
Rise Time	t_R				54	120	ns
Turn-OFF Delay Time	$t_{D(OFF)}$				75	160	ns
Fall-Time	t_F				47	105	ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current	I_S				12	A	
Maximum Body-Diode Pulsed Current	I_{SM}				48	A	
Drain-Source Diode Forward Voltage	V_{SD}	$I_S=12\text{A}$, $V_{GS}=0\text{V}$			1.5	V	
Body Diode Reverse Recovery Time	t_{rr}	$I_S=12\text{A}$, $V_{GS}=0\text{V}$, $di_F/dt=100\text{A}/\mu\text{s}$ (Note 1)		154		ns	
Body Diode Reverse Recovery Charge	Q_{RR}				0.45		μC

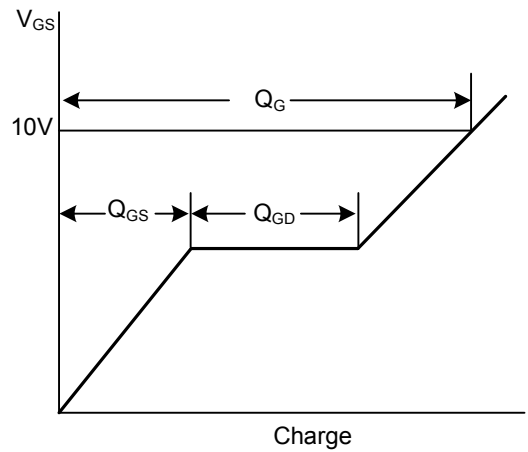
- Note: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$
2. Essentially independent of operating temperature

TEST CIRCUITS AND WAVEFORMS

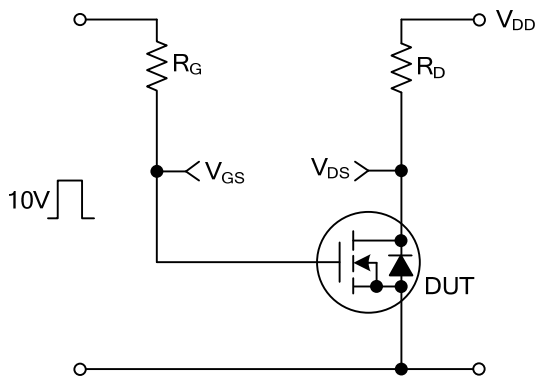
Gate Charge Test Circuit



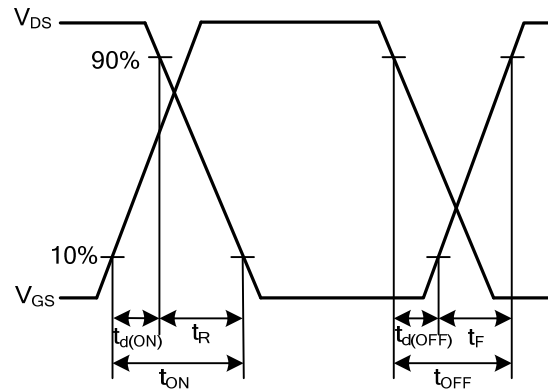
Gate Charge Waveforms



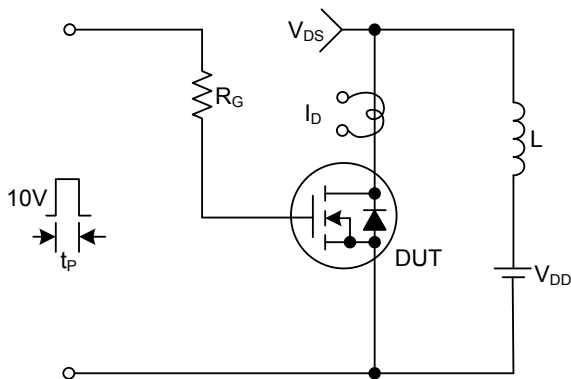
Resistive Switching Test Circuit



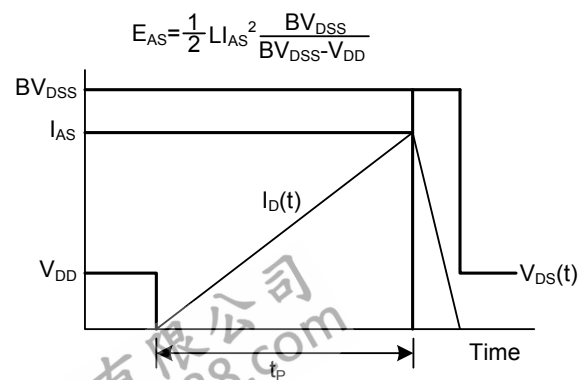
Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit

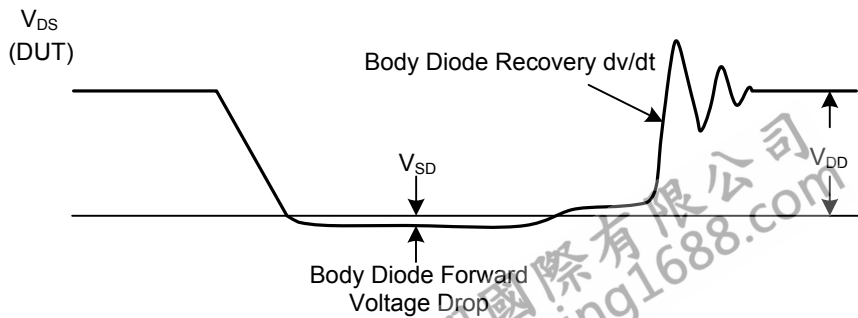
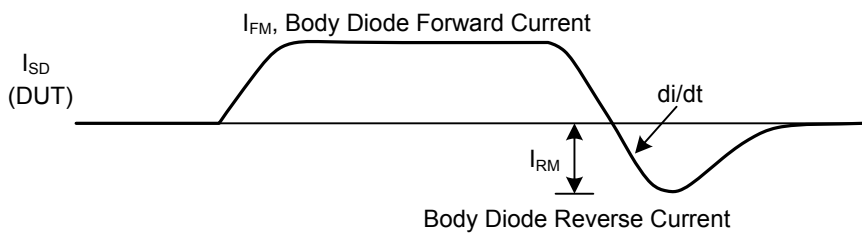
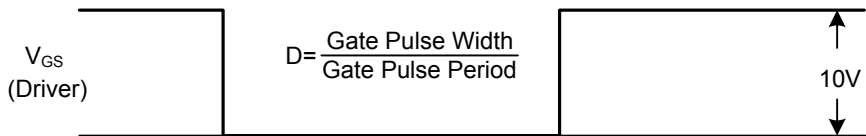
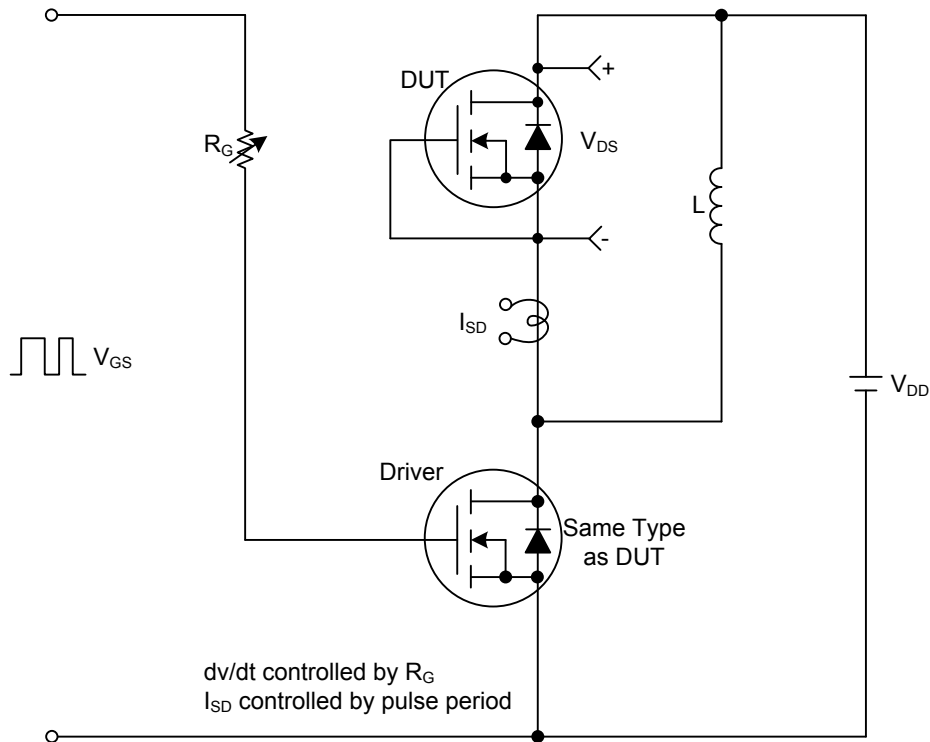


Unclamped Inductive Switching Waveforms

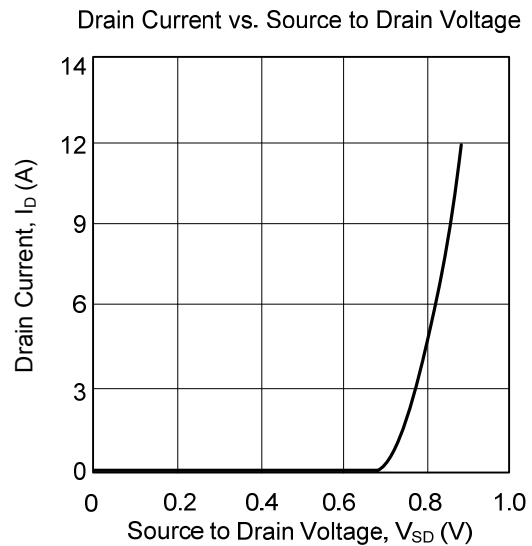
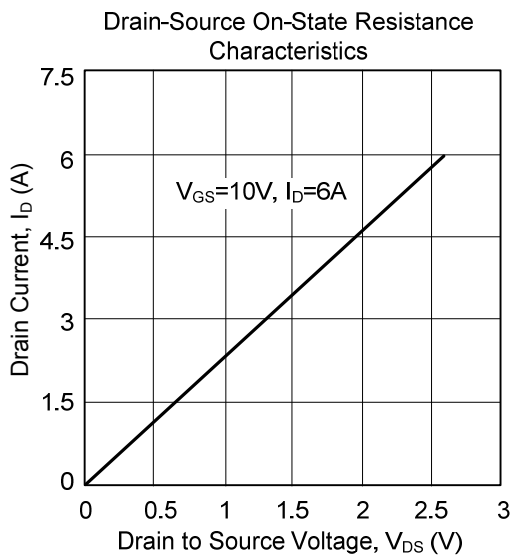
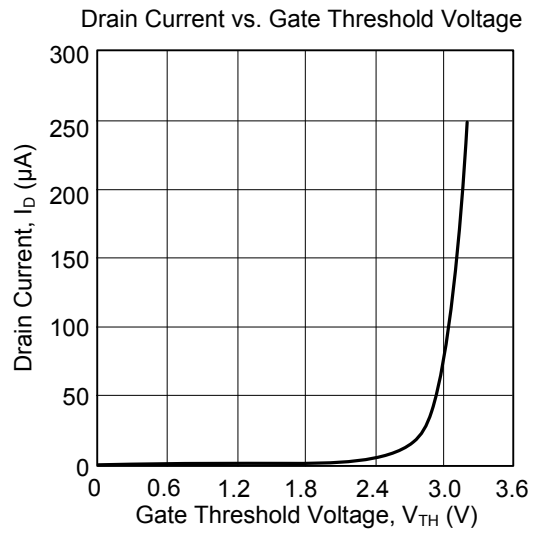
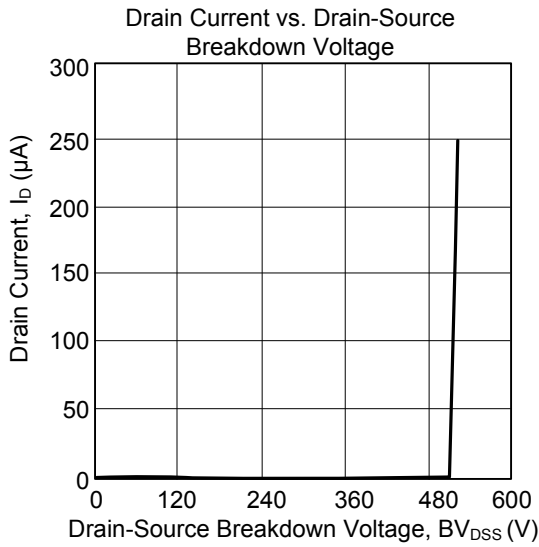


■ TEST CIRCUITS AND WAVEFORMS(Cont.)

Peak Diode Recovery dv/dt Test Circuit & Waveforms



TYPICAL CHARACTERISTICS



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